



## TGD N-Channel Enhancement Mode Power MOSFET

|                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                            |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------|
| <p><b>Description</b></p> <p>The TGD2302 uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.</p>                                                                                                    |                                                                                            |
| <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS} = 20V, I_D = 4A</math></li> <li>    <math>R_{DS(ON)} &lt; 59m\Omega @ V_{GS}=2.5V</math></li> <li>    <math>R_{DS(ON)} &lt; 45m\Omega @ V_{GS}=4.5V</math></li> <li>● High power and current handing capability</li> <li>● Lead free product is acquired</li> <li>● Surface mount package</li> </ul> | <p><b>Schematic diagram</b></p> <p><b>pin assignment</b></p> <p><b>SOT-23 top view</b></p> |
| <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Battery protection</li> <li>● Load switch</li> <li>● Power management</li> </ul>                                                                                                                                                                                                                                       |                                                                                            |

## Package Marking and Ordering Information

| Device Marking | Device  | Device Package | Reel Size | Tape width | Quantity   |
|----------------|---------|----------------|-----------|------------|------------|
| 2302           | TGD2302 | SOT-23         | Ø180mm    | 8 mm       | 3000 units |

Absolute Maximum Ratings ( $T_A=25^\circ C$  unless otherwise noted)

| Parameter                                        | Symbol         | Limit      | Unit |
|--------------------------------------------------|----------------|------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | 20         | V    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 12$   | V    |
| Drain Current-Continuous                         | $I_D$          | 4          | A    |
| Drain Current-Pulsed <small>(Note 1)</small>     | $I_{DM}$       | 10         | A    |
| Maximum Power Dissipation                        | $P_D$          | 1          | W    |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 To 150 | °C   |

## Thermal Characteristic

|                                                                 |                 |     |      |
|-----------------------------------------------------------------|-----------------|-----|------|
| Thermal Resistance, Junction-to-Ambient <small>(Note 2)</small> | $R_{\theta JA}$ | 125 | °C/W |
|-----------------------------------------------------------------|-----------------|-----|------|

Electrical Characteristics ( $T_A=25^\circ C$  unless otherwise noted)

| Parameter                       | Symbol     | Condition                | Min | Typ | Max | Unit    |
|---------------------------------|------------|--------------------------|-----|-----|-----|---------|
| <b>Off Characteristics</b>      |            |                          |     |     |     |         |
| Drain-Source Breakdown Voltage  | $BV_{DSS}$ | $V_{GS}=0V I_D=250\mu A$ | 20  | 22  | -   | V       |
| Zero Gate Voltage Drain Current | $I_{DSS}$  | $V_{DS}=20V, V_{GS}=0V$  | -   | -   | 1   | $\mu A$ |

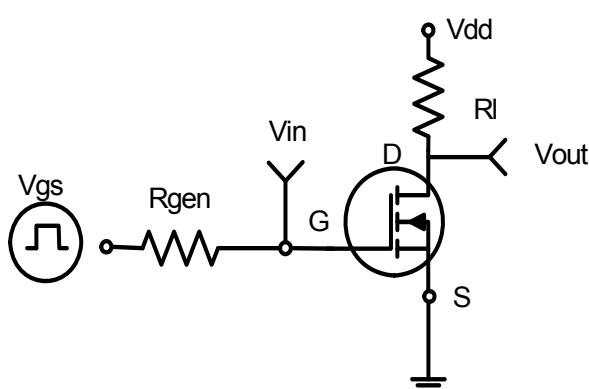


| Parameter                                                | Symbol       | Condition                                            | Min | Typ  | Max       | Unit      |
|----------------------------------------------------------|--------------|------------------------------------------------------|-----|------|-----------|-----------|
| Gate-Body Leakage Current                                | $I_{GSS}$    | $V_{GS}=\pm 12V, V_{DS}=0V$                          | -   | -    | $\pm 100$ | nA        |
| <b>On Characteristics</b> <small>(Note 3)</small>        |              |                                                      |     |      |           |           |
| Gate Threshold Voltage                                   | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                        | 0.5 | 0.85 | 1.2       | V         |
| Drain-Source On-State Resistance                         | $R_{DS(ON)}$ | $V_{GS}=2.5V, I_D=2.5A$                              | -   | 37   | 59        | $m\Omega$ |
|                                                          |              | $V_{GS}=4.5V, I_D=2.9A$                              | -   | 30   | 45        | $m\Omega$ |
| Forward Transconductance                                 | $g_{FS}$     | $V_{DS}=5V, I_D=2.9A$                                | -   | 8    | -         | S         |
| <b>Dynamic Characteristics</b> <small>(Note 4)</small>   |              |                                                      |     |      |           |           |
| Input Capacitance                                        | $C_{iss}$    | $V_{DS}=10V, V_{GS}=0V, F=1.0MHz$                    | -   | 300  | -         | PF        |
| Output Capacitance                                       | $C_{oss}$    |                                                      | -   | 120  | -         | PF        |
| Reverse Transfer Capacitance                             | $C_{rss}$    |                                                      | -   | 80   | -         | PF        |
| <b>Switching Characteristics</b> <small>(Note 4)</small> |              |                                                      |     |      |           |           |
| Turn-on Delay Time                                       | $t_{d(on)}$  | $V_{DD}=10V, I_D=2.9A, V_{GS}=4.5V, R_{GEN}=6\Omega$ | -   | 10   | 15        | nS        |
| Turn-on Rise Time                                        | $t_r$        |                                                      | -   | 50   | 85        | nS        |
| Turn-Off Delay Time                                      | $t_{d(off)}$ |                                                      | -   | 17   | 45        | nS        |
| Turn-Off Fall Time                                       | $t_f$        |                                                      | -   | 10   | 20        | nS        |
| Total Gate Charge                                        | $Q_g$        | $V_{DS}=10V, I_D=2.9A, V_{GS}=4.5V$                  | -   | 4.0  | 10        | nC        |
| Gate-Source Charge                                       | $Q_{gs}$     |                                                      | -   | 0.65 | -         | nC        |
| Gate-Drain Charge                                        | $Q_{gd}$     |                                                      | -   | 1.2  | -         | nC        |
| <b>Drain-Source Diode Characteristics</b>                |              |                                                      |     |      |           |           |
| Diode Forward Voltage <small>(Note 3)</small>            | $V_{SD}$     | $V_{GS}=0V, I_s=2.9A$                                | -   | 0.75 | 1.2       | V         |
| Diode Forward Current <small>(Note 2)</small>            | $I_s$        |                                                      | -   | -    | 4         | A         |

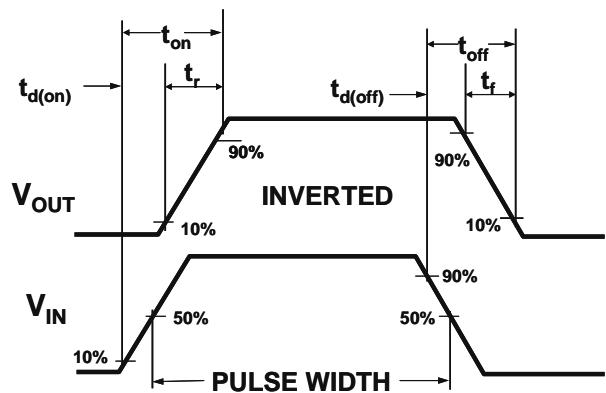
**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

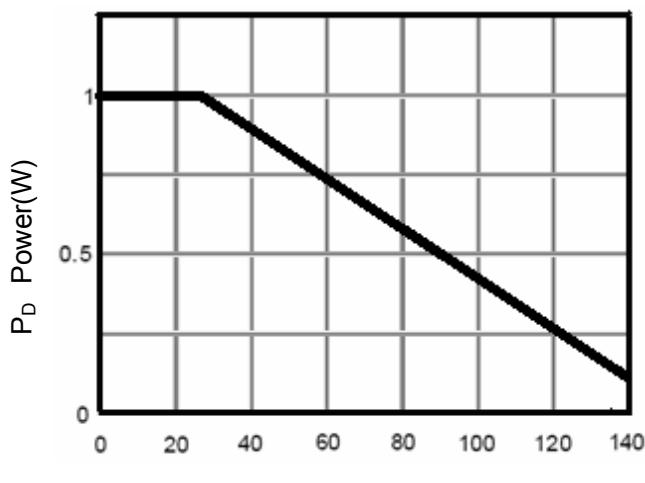
### Typical Electrical and Thermal Characteristics



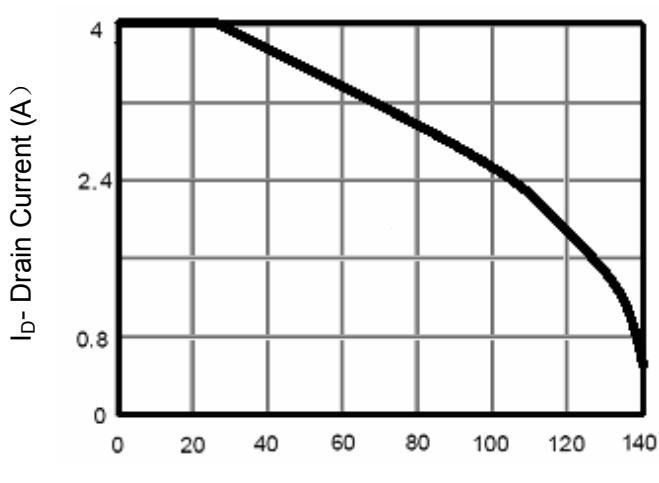
**Figure 1:Switching Test Circuit**



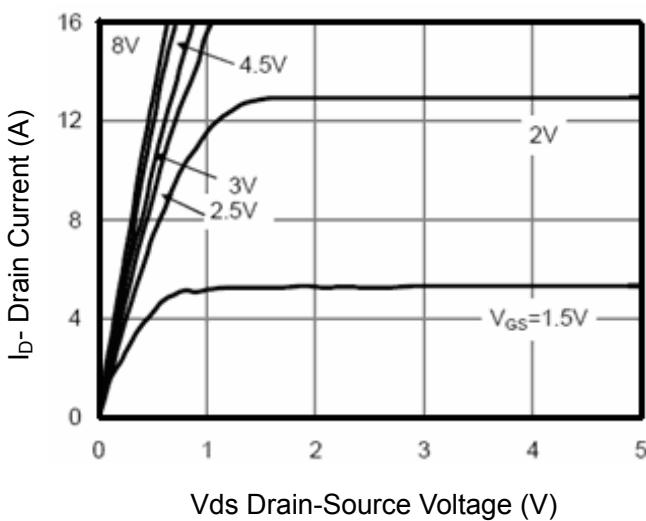
**Figure 2:Switching Waveforms**



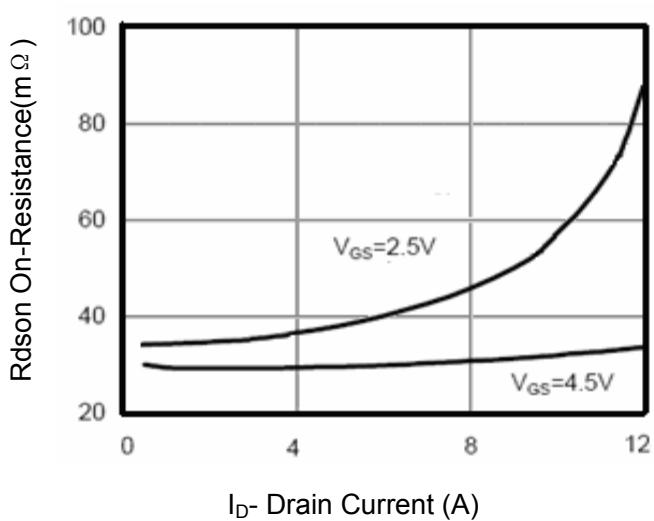
**Figure 3 Power Dissipation**



**Figure 4 Drain Current**



**Figure 5 Output Characteristics**



**Figure 6 Drain-Source On-Resistance**

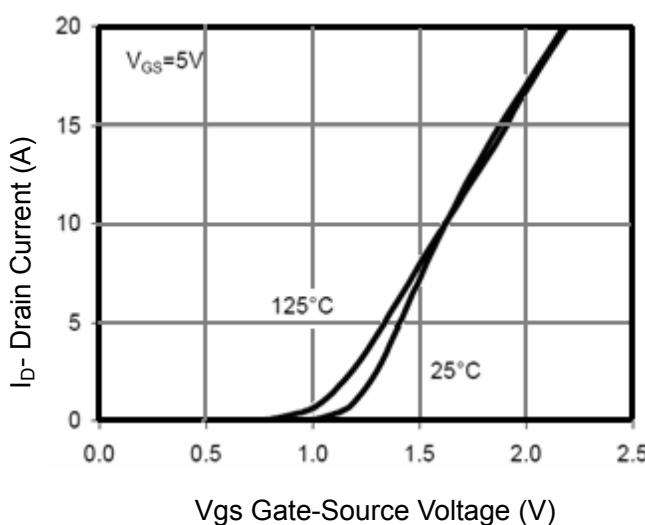


Figure 7 Transfer Characteristics

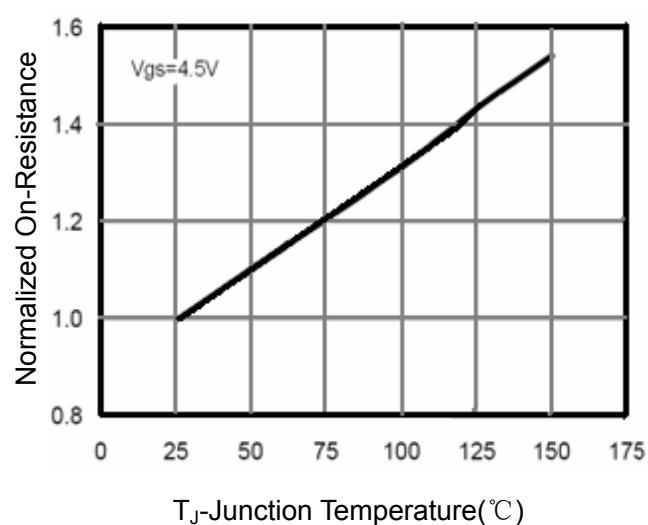


Figure 8 Drain-Source On-Resistance

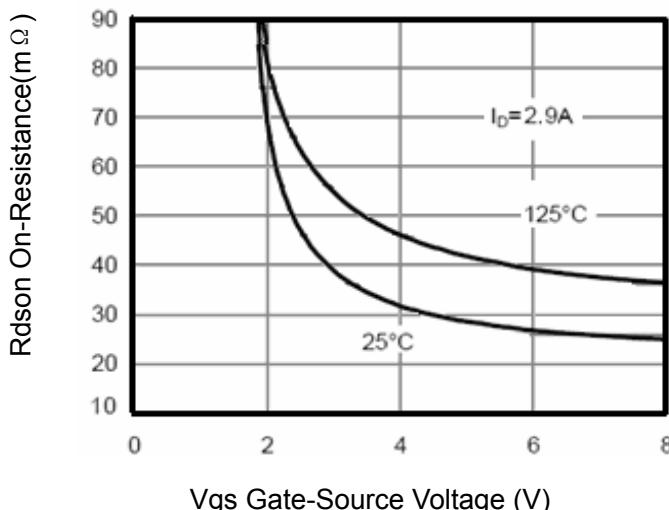


Figure 9  $R_{DSON}$  vs  $V_{GS}$

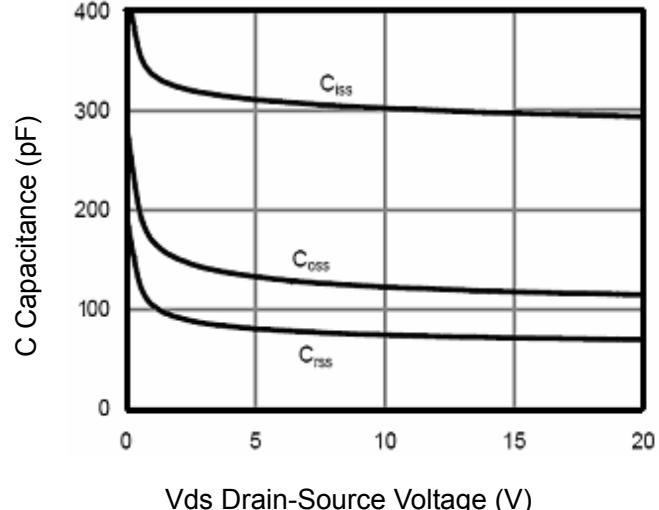


Figure 10 Capacitance vs  $V_{DS}$

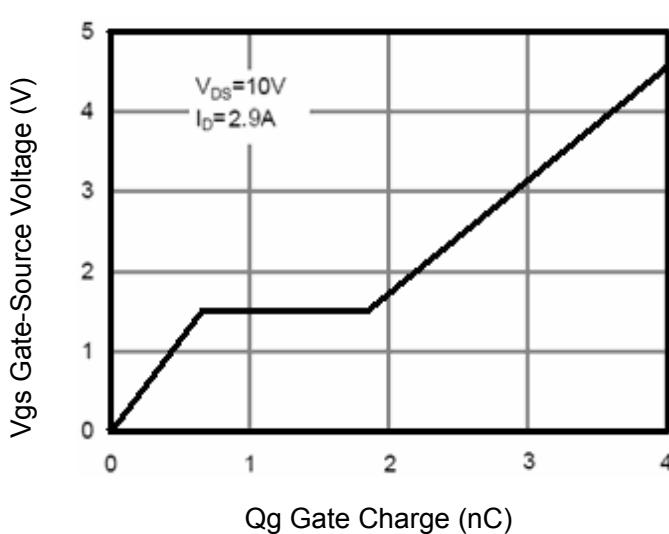


Figure 11 Gate Charge

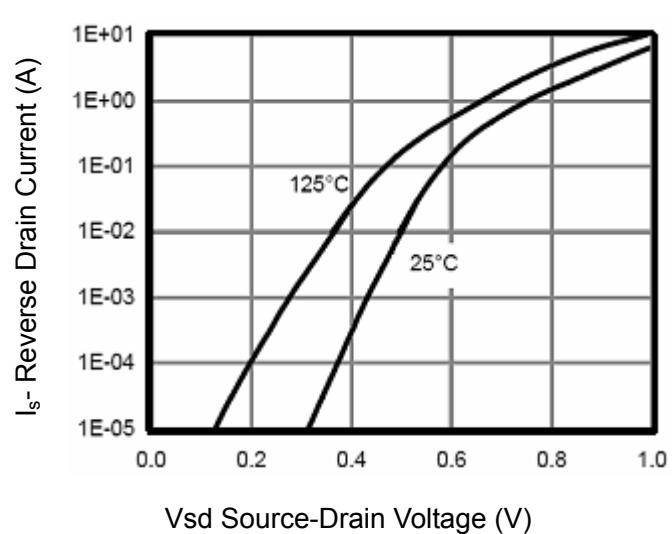
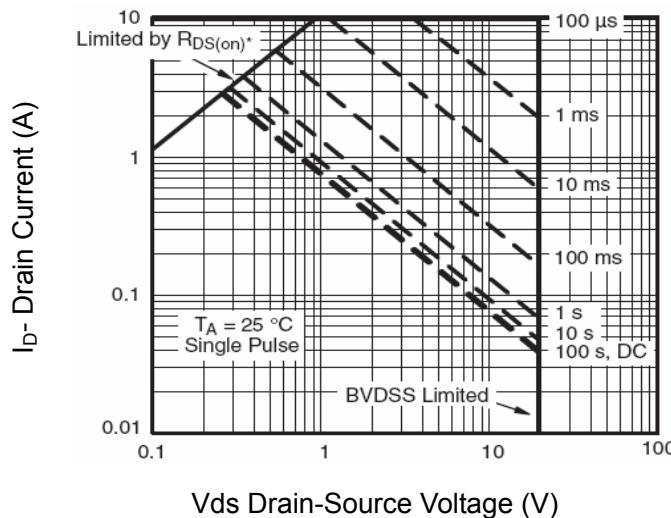
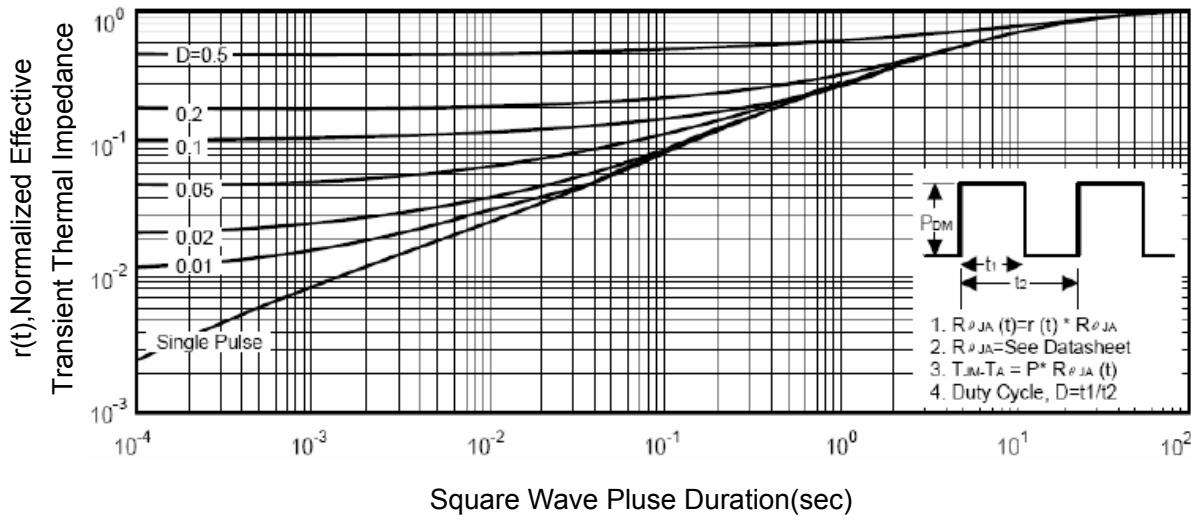


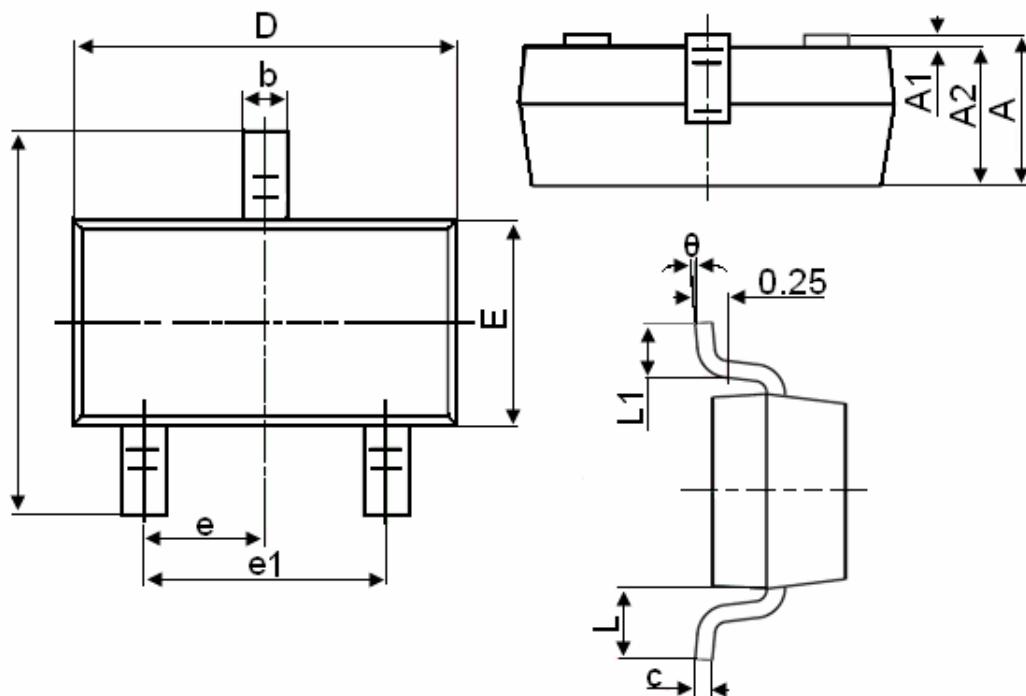
Figure 12 Source- Drain Diode Forward



**Figure 13 Safe Operation Area**



**Figure 14 Normalized Maximum Transient Thermal Impedance**

**SOT-23 Package Information**


| Symbol | Dimensions in Millimeters |       |
|--------|---------------------------|-------|
|        | MIN.                      | MAX.  |
| A      | 0.900                     | 1.150 |
| A1     | 0.000                     | 0.100 |
| A2     | 0.900                     | 1.050 |
| b      | 0.300                     | 0.500 |
| c      | 0.080                     | 0.150 |
| D      | 2.800                     | 3.000 |
| E      | 1.200                     | 1.400 |
| E1     | 2.250                     | 2.550 |
| e      | 0.950TYP                  |       |
| e1     | 1.800                     | 2.000 |
| L      | 0.550REF                  |       |
| L1     | 0.300                     | 0.500 |
| θ      | 0°                        | 8°    |

**Notes**

1. All dimensions are in millimeters.
2. Tolerance  $\pm 0.10\text{mm}$  (4 mil) unless otherwise specified
3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
4. Dimension L is measured in gauge plane.
5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.